

ZXTC2061E6

12V COMPLEMENTARY MEDIUM POWER TRANSISTOR IN SOT26

Features

- NPN + PNP Combination
- BV_{CEO} > 12 (-12)V
- BV_{EBO} > 7 (-7)V
- Continuous Collector Current I_C = 5 (-3.5)A
- V_{CE(sat)} < 32 (-70)mV @ 1A
- $R_{CE(sat)} = 25 (45) m\Omega$
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- Qualified to AEC-Q101 Standards for High Reliability

Description

Advanced process capability has been used to achieve this high performance device. Combining NPN and PNP transistors in the SOT26 package provides a compact solution for the intended applications.

Mechanical Data

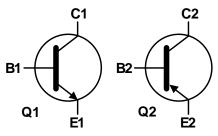
- Case: SOT26
- Case Material: Molded Plastic, "Green" Molding Compound;
 UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish Matte Tin Plated Leads, Solderable per MIL-STD-202, Method 208 (63)
- Weight: 0.015 grams (Approximate)

Applications

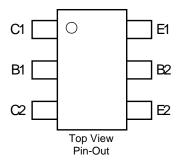
- MOSFET and IGBT Gate Driving
- Motor Drive







Device Symbol



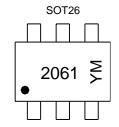
Ordering Information (Note 4)

Product	Complianace	Marking	Reel size (inches)	Tape width (mm)	Quantity per reel
ZXTC2061E6TA	AEC-Q101	2061	7	8	3,000

Notes:

- 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.
- 2. See http://www.diodes.com/quality/lead_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at http://www.diodes.com/products/packages.html.

Marking Information



2061 = Product Type Marking Code YM = Date Code Marking Y or \overline{Y} = Year (ex: C = 2015) M or \overline{M} = Month (ex: 9 = September)

Date Code Key

Year	201	5	2016	2017	2018	2019	2020	202	1 20	22	2023	2024	2025
Code	С		D	E	F	G	Н	I	,	J	K	L	М
Monti	n	Jar	n Fel	Mar	Apr	May	Jun	Jul	Aug	Sep	Oct	Nov	Dec
Code)	1	2	3	4	5	6	7	8	9	0	N	D



Absolute Maximum Ratings - Q1 (NPN Transistor) (@TA = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit
Collector-Base Voltage	V _{CBO}	20	V
Collector-Emitter Voltage	V _{CEO}	12	V
Emitter-Base Voltage	V _{EBO}	7	V
Continuous Collector Current	Ic	5	Α
Peak Pulsed Collector Current	Ісм	12	A
Base Current	lв	1	Α

Absolute Maximum Ratings - Q2 (PNP Transistor) (@TA = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit
Collector-Base Voltage	V _{CBO}	-12	V
Collector-Emitter Voltage	V _{CEO}	-12	V
Emitter-Base Voltage	V _{EBO}	-7	V
Continuous Collector Current	Ic	-3.5	Α
Peak Pulsed Collector Current	I _{CM}	-10	Α
Base Current	I _B	-1	А

Thermal Characteristics (@TA = +25°C, unless otherwise specified.)

Characteristic		Symbol	Value	Unit	
	(Notes 5 & 9)		0.7 5.6		
	(Notes 6 & 9)		0.9 7.2		
Power Dissipation Linear Derating Factor	(Notes 6 & 10)	P_{D}	1.1 8.8	W mW/°C	
	(Notes 7 & 9)		1.1 8.8	1	
	(Notes 8 & 9)		1.7 13.6		
	(Notes 5 & 9)		179		
	(Notes 6 & 9)		139		
Thermal Resistance, Junction to Ambient	(Notes 6 & 10)	$R_{\theta JA}$	113	900	
	(Notes 7 & 9)		113	°C/W	
	(Notes 8 & 9)		73	1	
Thermal Resistance, Junction to Lead	(Note 11)	R _{0JL}	87.58		
Operating and Storage Temperature Range		T _J , T _{STG}	-55 to +150	°C	

ESD Ratings (Note 12)

Characteristic	Symbol	Value	Unit	JEDEC Class
Electrostatic Discharge - Human Body Model	ESD HBM	4,000	V	3A
Electrostatic Discharge - Machine Model	ESD MM	400	V	С

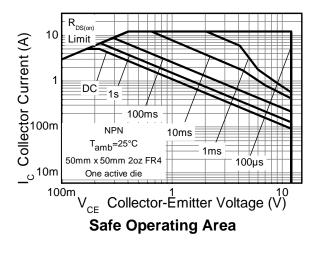
Notes:

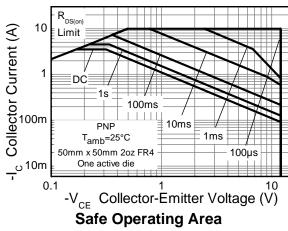
- 5. For a device surface mounted on 15mm x 15mm FR4 PCB with high coverage of single sided 1oz copper, in still air conditions; the device is measured when operating in a steady-state condition.
- when operating in a steady-state condition.

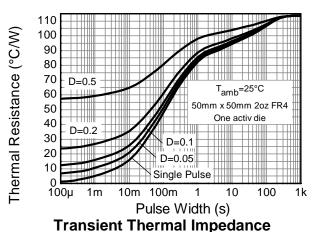
 6. Same as Note 5, except the device is surface mounted on 25mm x 25mm 1oz copper.
- 7. Same as Note 5, except the device is surface mounted on 50mm x 50mm 2oz copper.
- 8. Same as Note 7, except the device is measured at t < 5 seconds.
- 9. For device with one active die, both collectors attached to a common heatsink.
- 10. For device with two active dice running at equal power, split heatsink 50% to each collector.
- 11. Thermal resistance from junction to solder-point (at the end of the collector lead).
- 12. Refer to JEDEC specification JESD22-A114 and JESD22-A115.

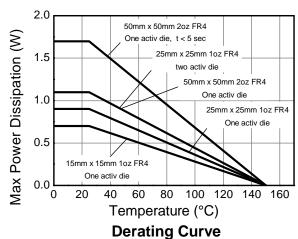


Thermal Characteristics and Derating Information











Electrical Characteristics - Q1 (NPN Transistor) (@TA = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
OFF CHARACTERISTICS	Symbol	IVIIII	тур	IVIAX	Oilit	rest condition
Collector-Base Breakdown Voltage	BV _{CBO}	20	40	_	V	$I_C = 100\mu A, I_E = 0$
Collector-Emitter Breakdown Voltage (Note 13)	BV _{CEO}	12	17	_	V	I _C = 10mA, I _B = 0
Emitter-Base Breakdown Voltage	BV _{EBO}	7	8.4	_	V	$I_E = 100 \mu A, I_C = 0$
Collector Cut-Off Current	I _{CBO}	_	<1	50 0.5	nΑ μΑ	V _{CB} = 20V V _{CB} = 20V, T _A = +100°C
Collector Cut-Off Current	I _{EBO}	_	<1	50	nA	V _{EB} = 5.6V
ON CHARACTERISTICS (Note 13)						
DC Current Gain	h _{FE}	500 480 260	800 750 390	1,500	_	$I_C = 10 \text{mA}, V_{CE} = 2 \text{V}$ $I_C = 1.0 \text{A}, V_{CE} = 2 \text{V}$ $I_C = 5 \text{A}, V_{CE} = 2 \text{V}$
Collector-Emitter Saturation Voltage	V _{CE(sat)}	_	32 50 65 145	40 60 80 180	mV	$I_C = 1.0A$, $I_B = 100mA$ $I_C = 1.0A$, $I_B = 10mA$ $I_C = 2.0A$, $I_B = 40mA$ $I_C = 5A$, $I_B = 100mA$
Base-Emitter Saturation Voltage	V _{BE(sat)}	_	920	1,000	mV	I _C = 5A, I _B = 100mA
Base-Emitter Turn-On Voltage	V _{BE(on)}	_	810	900	mV	I _C = 5A, V _{CE} = 2V
SMALL SIGNAL CHARACTERISTICS						
Output Capacitance	Cobo	_	26	35	pF	V _{CB} = 10V, f = 1.0MHz
Current Gain-Bandwidth Product	f⊤	_	260	_	MHz	V _{CE} = 10V, I _C = 50mA, f = 100MHz
Delay Time	t _d		71	_	ns	
Rise Time	t _r	_	70	_	ns	V 10V I 10 I 10mA
Storage Time	ts	_	233	_	ns	$V_{CC} = 10V$, $I_C = 1A$, $I_{B1} = -I_{B2} = 10mA$
Fall Time	t _f		72	_	ns	

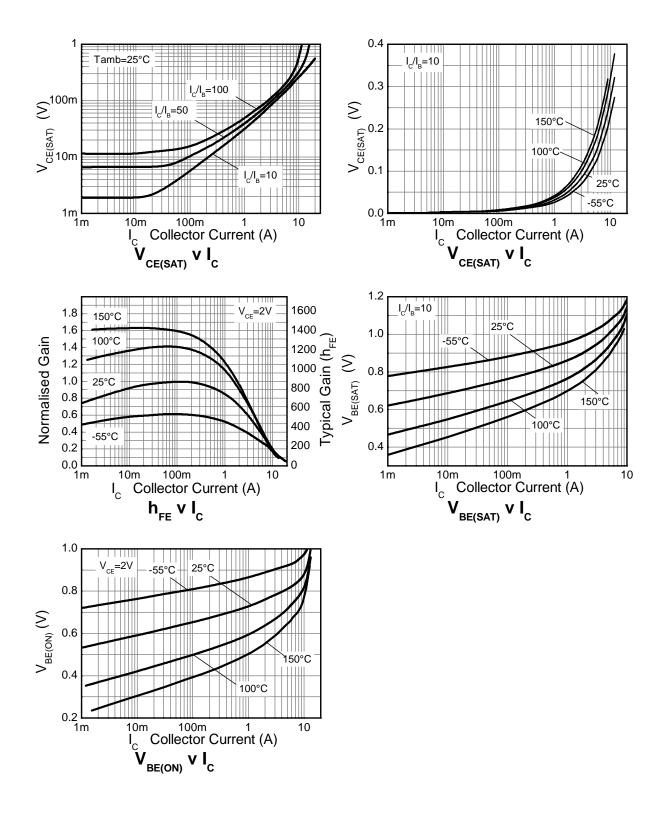
Electrical Characteristics - Q2 (PNP Transistor) (@TA = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
OFF CHARACTERISTICS						
Collector-Base Breakdown Voltage	BV _{CBO}	-12	-35	_	V	$I_C = -100\mu A, I_E = 0$
Collector-Emitter Breakdown Voltage (Note 13)	BV _{CEO}	-12	-25	_	V	$I_C = -10 \text{mA}, I_B = 0$
Emitter-Base Breakdown Voltage	BV _{EBO}	-7	-8.4	_	V	$I_E = -100 \mu A, I_C = 0$
Collector Cut-Off Current	I _{CBO}		< -1	-50 -0.5	nΑ μΑ	V _{CB} = -12V V _{CB} = -12V, T _A = +100°C
Collector Cut-Off Current	I _{EBO}	_	< -1	-50	nA	V _{EB} = -5.6V
ON CHARACTERISTICS (Note 13)						
DC Current Gain	h _{FE}	500 290 75	800 450 100	1500 — —	_	I _C = -10mA, V _{CE} = -2V I _C = -1.0A, V _{CE} = -2V I _C = -3.5A, V _{CE} = -2V
Collector-Emitter Saturation Voltage	V _{CE(sat)}		-55 -170 -220 -150	-70 -265 -360 -200	mV	I _C = -1.0A, I _B = -100mA I _C = -1.0A, I _B = -10mA I _C = -2.0A, I _B = -40mA I _C = -3.5A, I _B = -350mA
Base-Emitter Saturation Voltage	V _{BE(sat)}	_	-955	-1,050	mV	$I_C = -3.5A$, $I_B = -350mA$
Base-Emitter Turn-On Voltage	V _{BE(on)}	_	-830	-900	mV	I _C = -3.5A, V _{CE} = -2V
SMALL SIGNAL CHARACTERISTICS						
Output Capacitance	C _{obo}	_	17	25	рF	$V_{CB} = -10V, f = 1.0MHz$
Current Gain-Bandwidth Product	f⊤		310	_	MHz	$V_{CE} = -10V$, $I_{C} = -50mA$, $f = 100MHz$
Delay Time	t _d	-	41	_	ns	
Rise Time	t _r	_	62	_	ns	$V_{CC} = -10V, I_C = -1A,$
Storage Time	ts	_	179	_	ns	$I_{B1} = -I_{B2} = -10 \text{mA}$
Fall Time	t _f	_	65	_	ns	

Note: 13. Measured under pulsed conditions. Pulse width \leq 300 μ s. Duty cycle \leq 2%.

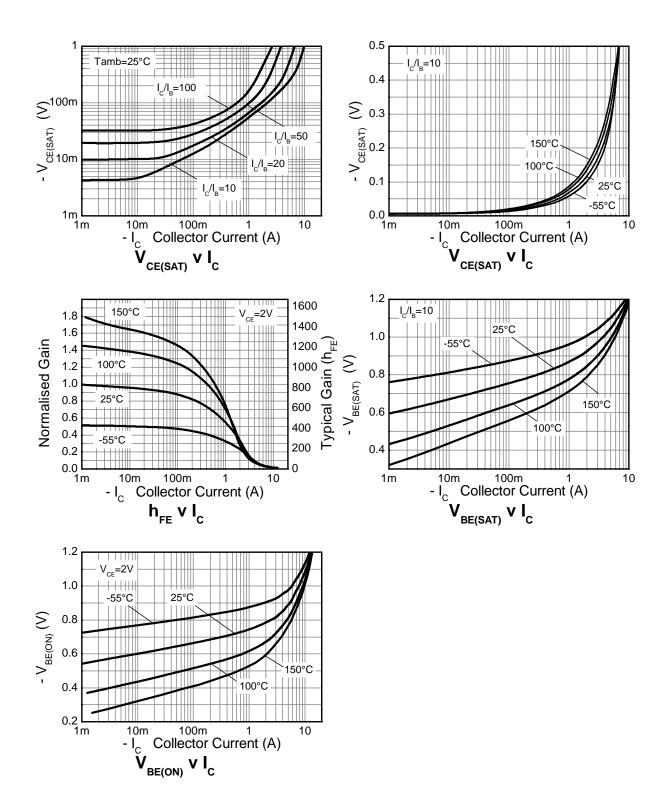


Typical Electrical Characteristics - Q1 (NPN Transistor) (@TA = +25°C, unless otherwise specified.)





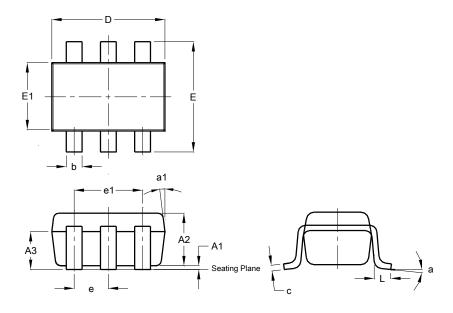
Typical Electrical Characteristics - Q2 (PNP Transistor) (@TA = +25°C, unless otherwise specified.)





Package Outline Dimensions

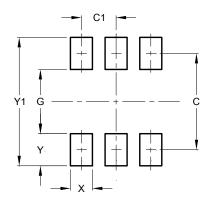
Please see AP02002 at http://www.diodes.com/datasheets/ap02002.pdf for the latest version.



SOT26						
Dim	Min	Max	Тур			
A1	0.013	0.10	0.05			
A2	1.00	1.30	1.10			
A3	0.70	0.80	0.75			
b	0.35	0.50	0.38			
С	0.10	0.20	0.15			
D	2.90	3.10	3.00			
е	-	-	0.95			
e1	-	-	1.90			
Е	2.70	3.00	2.80			
E1	1.50	1.70	1.60			
L	0.35	0.55	0.40			
а	-	-	8°			
a1	-	-	7°			
All	Dimen	sions	in mm			

Suggested Pad Layout

Please see AP02001 at http://www.diodes.com/datasheets/ap02001.pdf for the latest version.



Dimensions	Value (in mm)
С	2.40
C1	0.95
G	1.60
Х	0.55
Y	0.80
V1	3.20



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